

Features:

- Advanced trench process technology
- Ultra low $R_{DS(on)}$, typical 16mohm
- High avalanche energy, 100% test
- Fully characterized avalanche voltage and current

Description:

The SSF1020A is a new generation of middle voltage and high current N-Channel enhancement mode trench power MOSFET. This new technology increases the device reliability and electrical parameter repeatability. SSF1020A is assembled in high reliability and qualified assembly house.

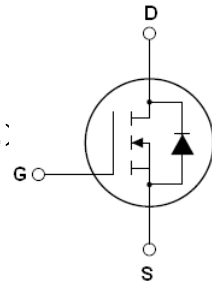
Application:

- Power switching application

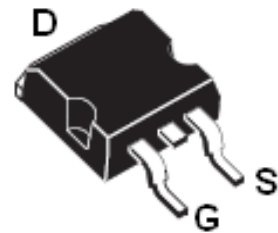
$I_D = 60A$

$BV = 100V$

$R_{DS(on)} = 20m\Omega$ (max.)



SSF1020A TOP View (D2PAK)



Absolute Maximum Ratings

	Parameter	Max.	Units
$I_D @ T_c = 25^\circ C$	Continuous drain current, $V_{GS} @ 10V$	60	A
$I_D @ T_c = 100^\circ C$	Continuous drain current, $V_{GS} @ 10V$	50	
I_{DM}	Pulsed drain current ①	240	
$P_D @ T_c = 25^\circ C$	Power dissipation	120	W
	Linear derating factor	2.0	W/ $^\circ C$
V_{GS}	Gate-to-Source voltage	± 20	V
E_{AS}	Single pulse avalanche energy ②	240	mJ
E_{AR}	Repetitive avalanche energy	TBD	
T_J T_{STG}	Operating Junction and Storage Temperature Range	-55 to +175	$^\circ C$

Thermal Resistance

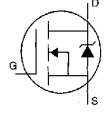
	Parameter	Min.	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-case	—	1.25	—	$^\circ C/W$
$R_{\theta JA}$	Junction-to-ambient	—	—	62	

Electrical Characteristics @ $T_J = 25^\circ C$ (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Test Conditions
BV_{DSS}	Drain-to-Source breakdown voltage	100	—	—	V	$V_{GS} = 0V, I_D = 250\mu A$
$R_{DS(on)}$	Static Drain-to-Source on-resistance	—	16	20	m Ω	$V_{GS} = 10V, I_D = 30A$
$V_{GS(th)}$	Gate threshold voltage	2.0	3.0	4.0	V	$V_{DS} = V_{GS}, I_D = 250\mu A$
g_{fs}	Forward transconductance	-	58	—	S	$V_{DS} = 5V, I_D = 30A$
I_{DSS}	Drain-to-Source leakage current	—	—	1	μA	$V_{DS} = 100V, V_{GS} = 0V$
		—	—	10		$V_{DS} = 100V, V_{GS} = 0V, T_J = 150^\circ C$
I_{GSS}	Gate-to-Source forward leakage	—	—	100	nA	$V_{GS} = 20V$

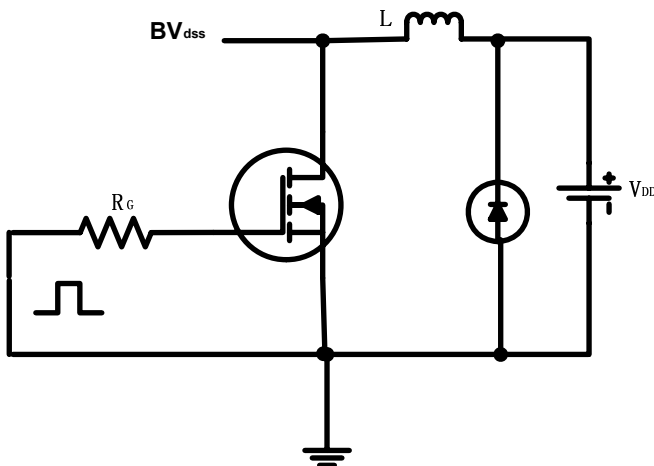
	Gate-to-Source reverse leakage	—	—	-100		$V_{GS} = -20V$
Q_g	Total gate charge	—	90	—	nC	$I_D = 30A$
Q_{gs}	Gate-to-Source charge	—	14	—		$V_{DD} = 30V$
Q_{gd}	Gate-to-Drain("Miller") charge	—	24	—		$V_{GS} = 10V$
$t_{d(on)}$	Turn-on delay time	—	18.2	—	nS	$V_{DD} = 30V$
t_r	Rise time	—	15.6	—		$I_D = 2A, R_L = 15\Omega$
$t_{d(off)}$	Turn-Off delay time	—	70.5	—		$R_G = 2.5\Omega$
t_f	Fall time	—	13.8	—		$V_{GS} = 10V$
C_{iss}	Input capacitance	—	3150	—	pF	$V_{GS} = 0V$
C_{oss}	Output capacitance	—	300	—		$V_{DS} = 25V$
C_{rss}	Reverse transfer capacitance	—	240	—		$f = 1.0MHz$

Source-Drain Ratings and Characteristics

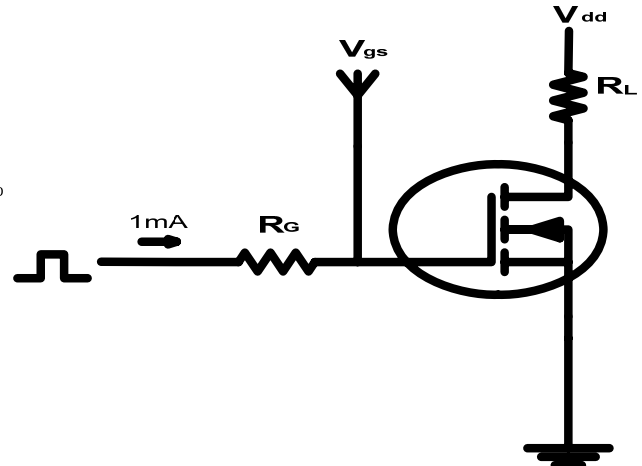
	Parameter	Min.	Typ.	Max.	Units	Test Conditions
I _S	Continuous Source Current (Body Diode)	—	—	60	A	MOSFET symbol showing the integral reverse p-n junction diode. 
I _{SM}	Pulsed Source Current (Body Diode) ①	—	—	240		
V _{SD}	Diode Forward Voltage	—	—	1.3	V	T _J =25°C, I _S =30A, V _{GS} =0V ③
t _{rr}	Reverse Recovery Time	—	57	—	nS	T _J =25°C, I _F =60A di/dt=100A/μs ③
Q _{rr}	Reverse Recovery Charge	—	107	—	nC	
t _{on}	Forward Turn-on Time	Intrinsic turn-on time is negligible (turn-on is dominated by L _s + L _D)				

Notes:

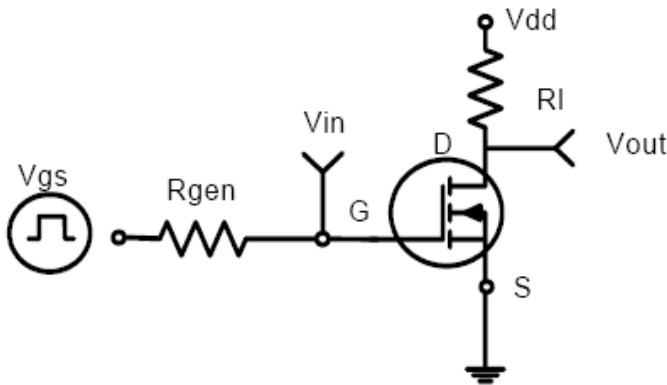
- ① Repetitive rating; pulse width limited by max junction temperature.
- ② Test condition: $L = 0.3mH$, $I_D = 40A$, $V_{DD} = 50V$
- ③ Pulse width $\leq 300\mu s$, duty cycle $\leq 1.5\%$; $R_G = 25\Omega$ Starting $T_J = 25^\circ C$



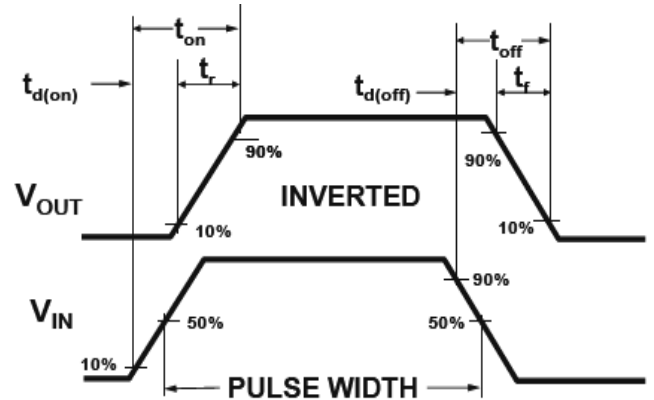
EAS test circuit



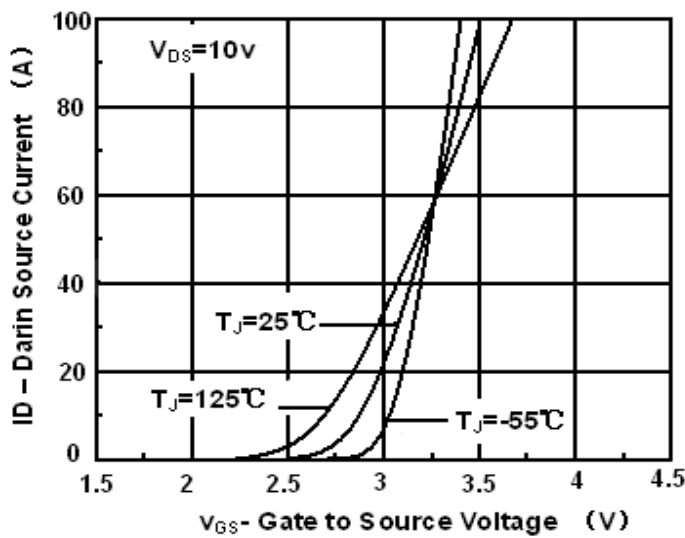
Gate charge test circuit



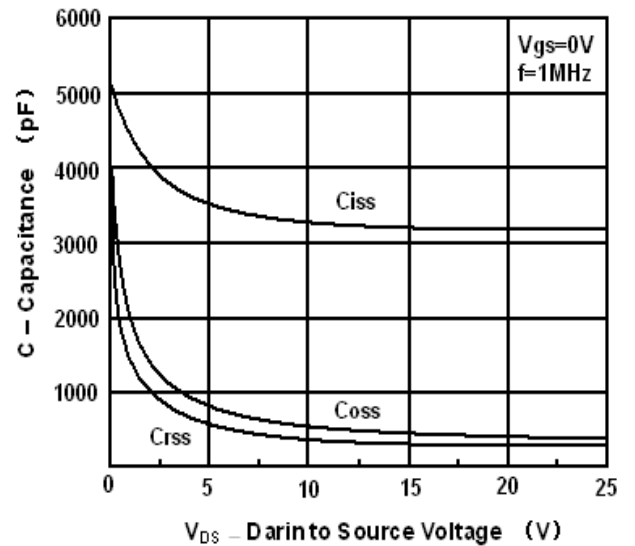
Switch Time Test Circuit:



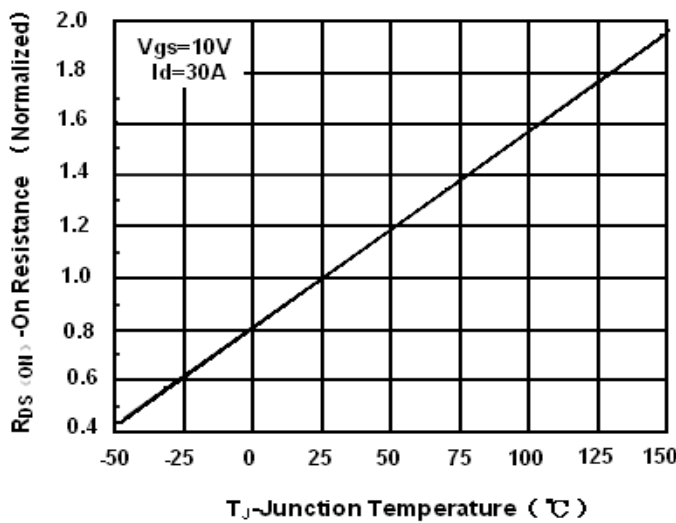
Switch Waveforms:



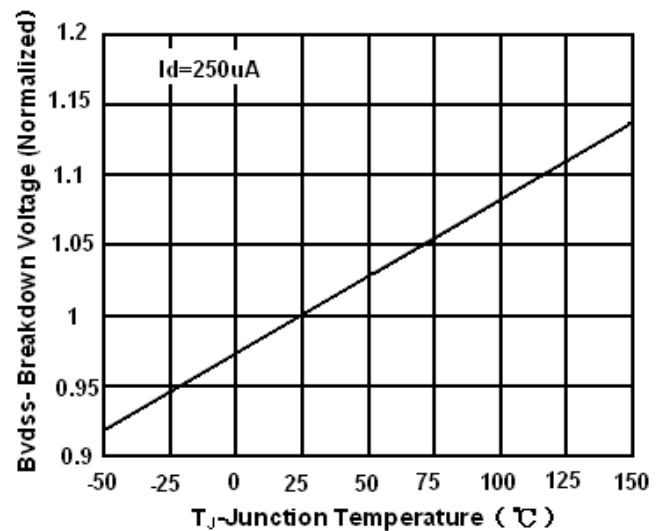
Transfer Characteristic



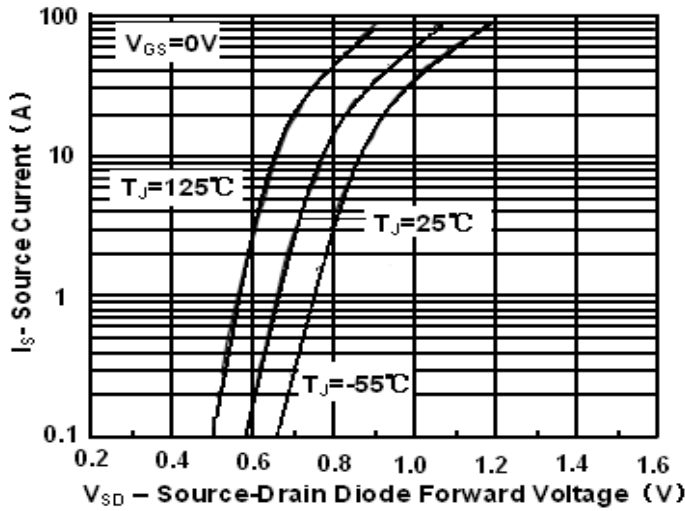
Capacitance:



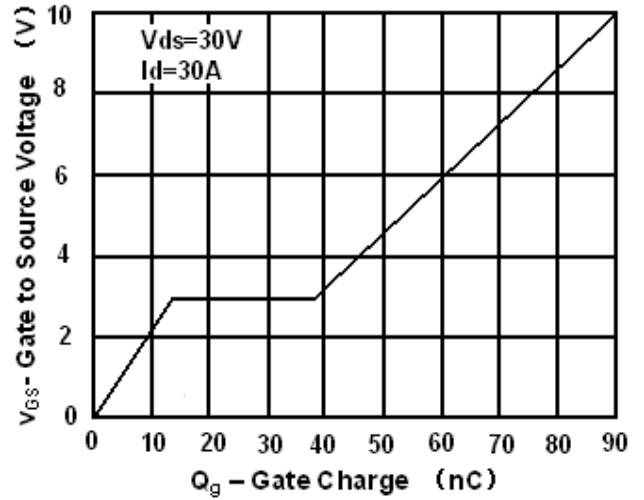
On Resistance vs Junction Temperature



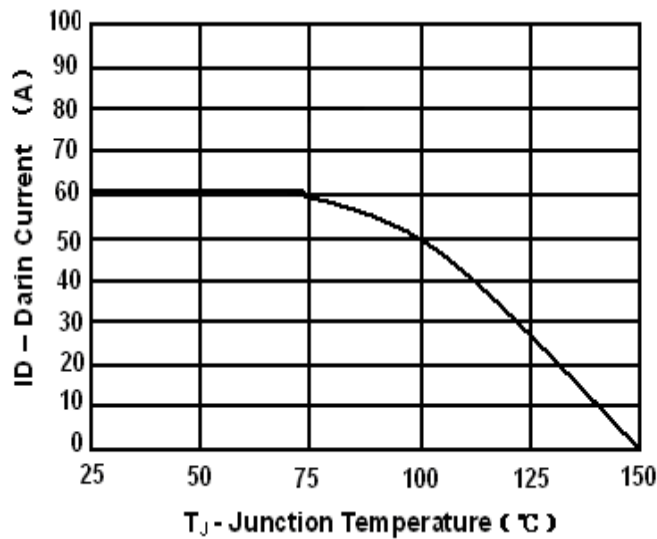
Breakdown Voltage vs Junction Temperature



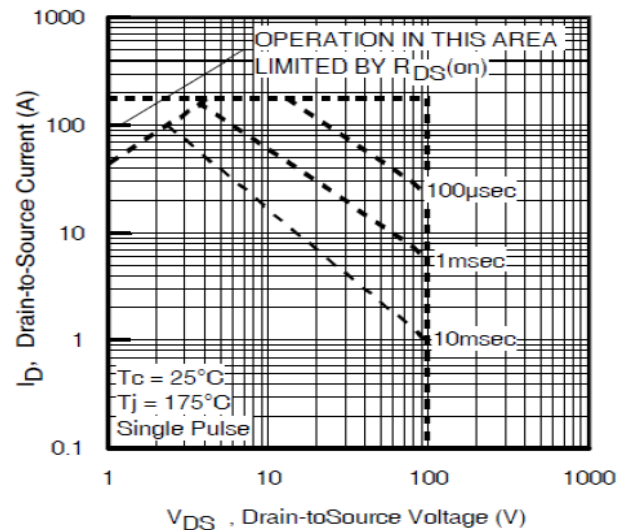
Source-Drain Diode Forward Voltage



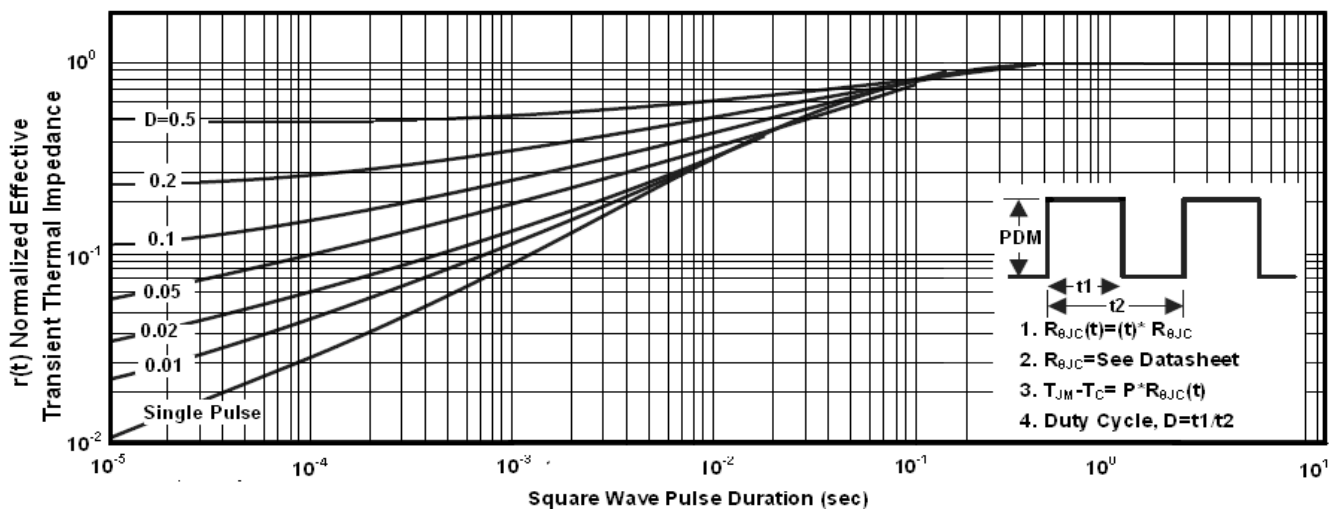
Gate Charge



Max Drain Current vs Junction Temperature



Safe Operation Area



Transient Thermal Impedance Curve

D2PAK MECHANICAL DATA:

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A	4.4		4.6	0.173		0.181
A1	2.49		2.69	0.098		0.106
A2	0.03		0.23	0.001		0.009
B	0.7		0.93	0.027		0.036
B2	1.14		1.7	0.044		0.067
C	0.45		0.6	0.017		0.023
C2	1.23		1.36	0.048		0.053
D	8.95		9.35	0.352		0.368
D1		8			0.315	
E	10		10.4	0.393		
E1		8.5			0.334	
G	4.88		5.28	0.192		0.208
L	15		15.85	0.590		0.625
L2	1.27		1.4	0.050		0.055
L3	1.4		1.75	0.055		0.068
M	2.4		3.2	0.094		0.126
R		0.4			0.015	
V2	0°		4°			

